

# Development of the Silicon Tracking System for the Compressed Baryonic Matter (CBM) Experiment at FAIR



Jürgen Eschke and Johann Heuser for the CBM Collaboration

GSI Helmholtz Center for Heavy Ion Research GmbH and FAIR GmbH, Darmstadt, Germany

<http://www.fair-center.eu/en/fair-users/experiments/cbm.html>

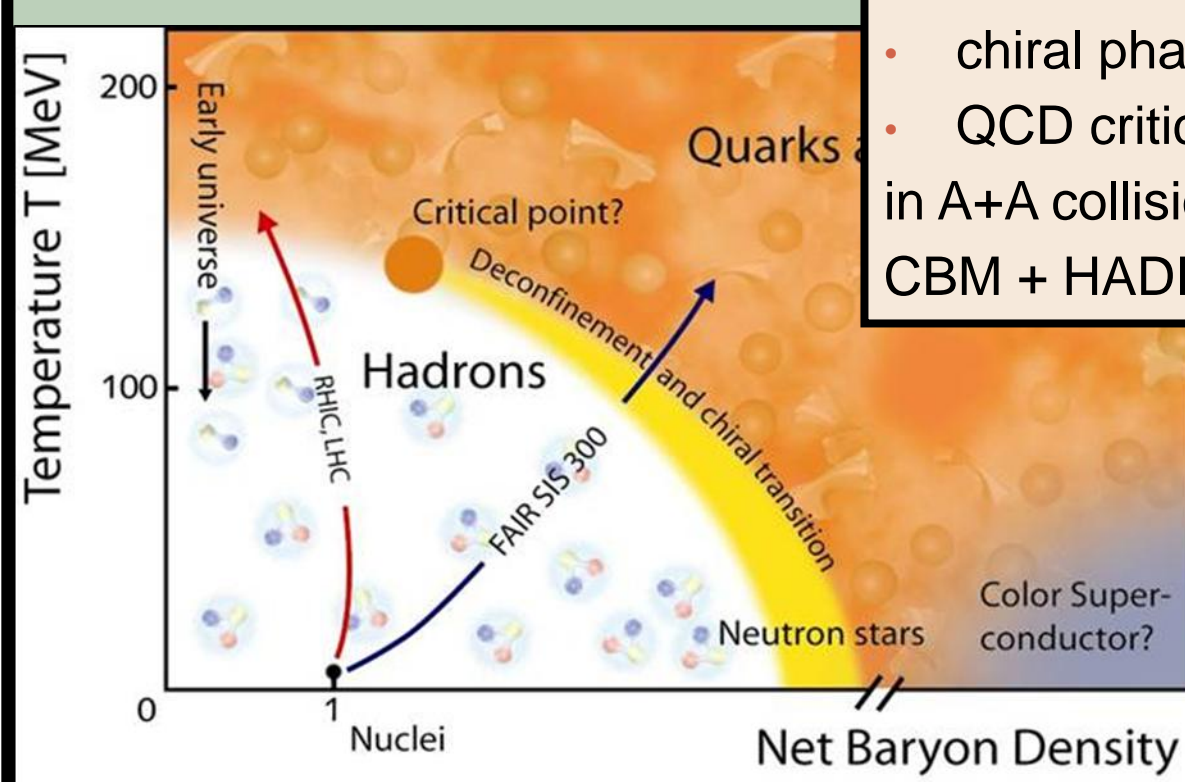


## Compressed Baryonic Matter @ FAIR – high $\mu_B$ , moderate T:

### Searching for the landmarks of the QCD phase diagram:

- first order deconfinement phase transition
- chiral phase transition (high baryon densities!)
- QCD critical endpoint

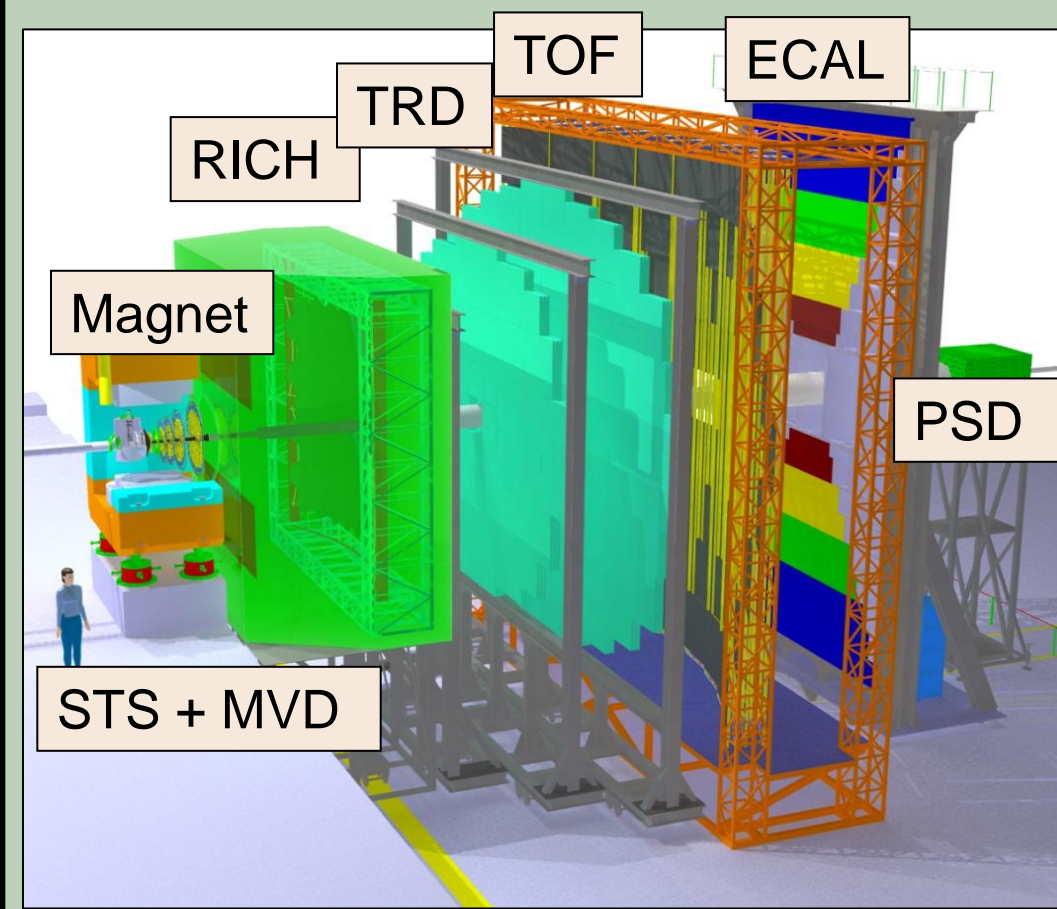
in A+A collisions from 2-45 AGeV starting in 2017  
CBM + HADES at SIS100 and CBM at SIS300



### Diagnostic probes of the high-density phase:

- open charm, charmonia
- low-mass vector mesons
- multistrange hyperons
- flow, fluctuations, correlations

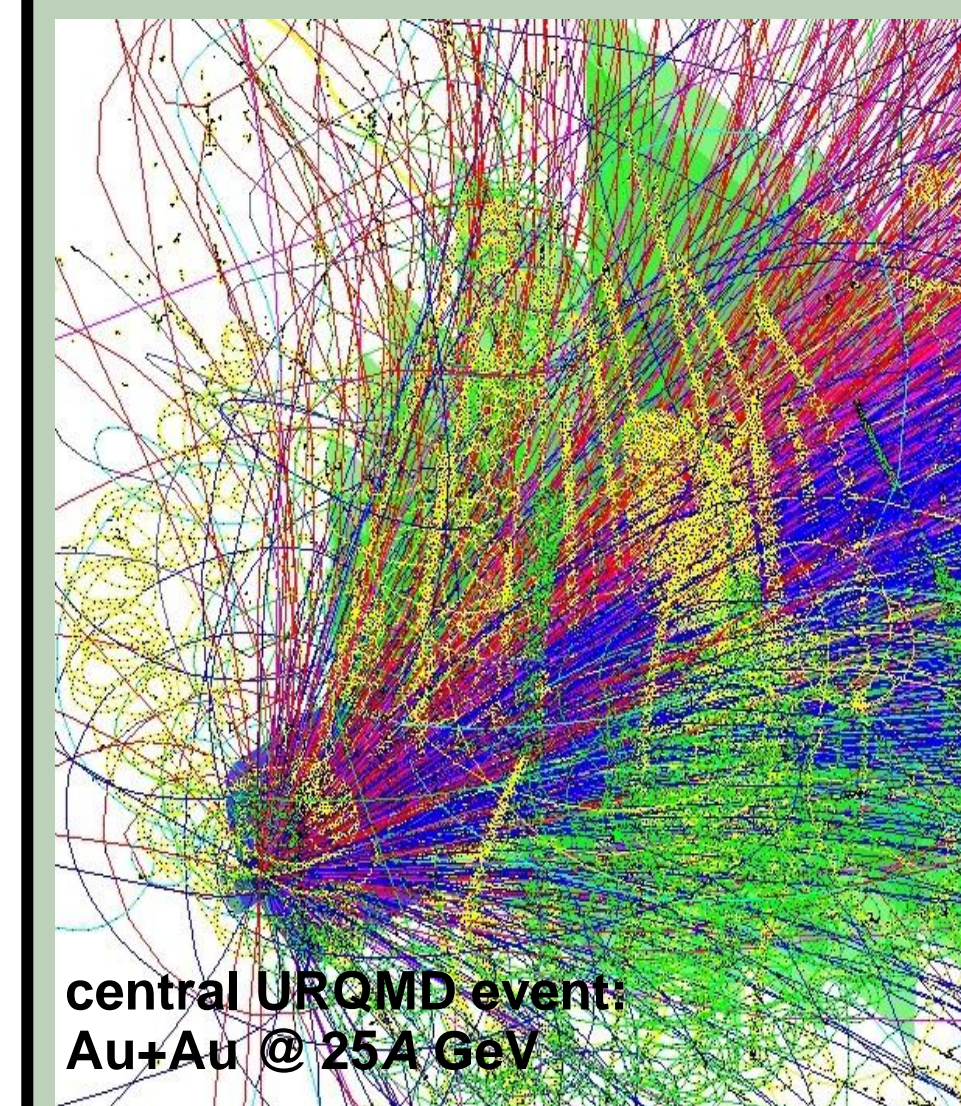
## Layout of the CBM experiment (e+e- set up)



### Tracking, momentum determination, vertex reconstruction:

- radiation hard silicon pixel/strip detectors (MVD+STS) in a magnetic dipole field
- hadron ID: TOF (& RICH)
- electron ID: RICH & TRD & TOF
- photons,  $\pi^0$ ,  $\eta$ : ECAL
- PSD for event characterization
- high speed DAQ and online event selection  $\rightarrow$  rare probes!

## Tracking Challenge



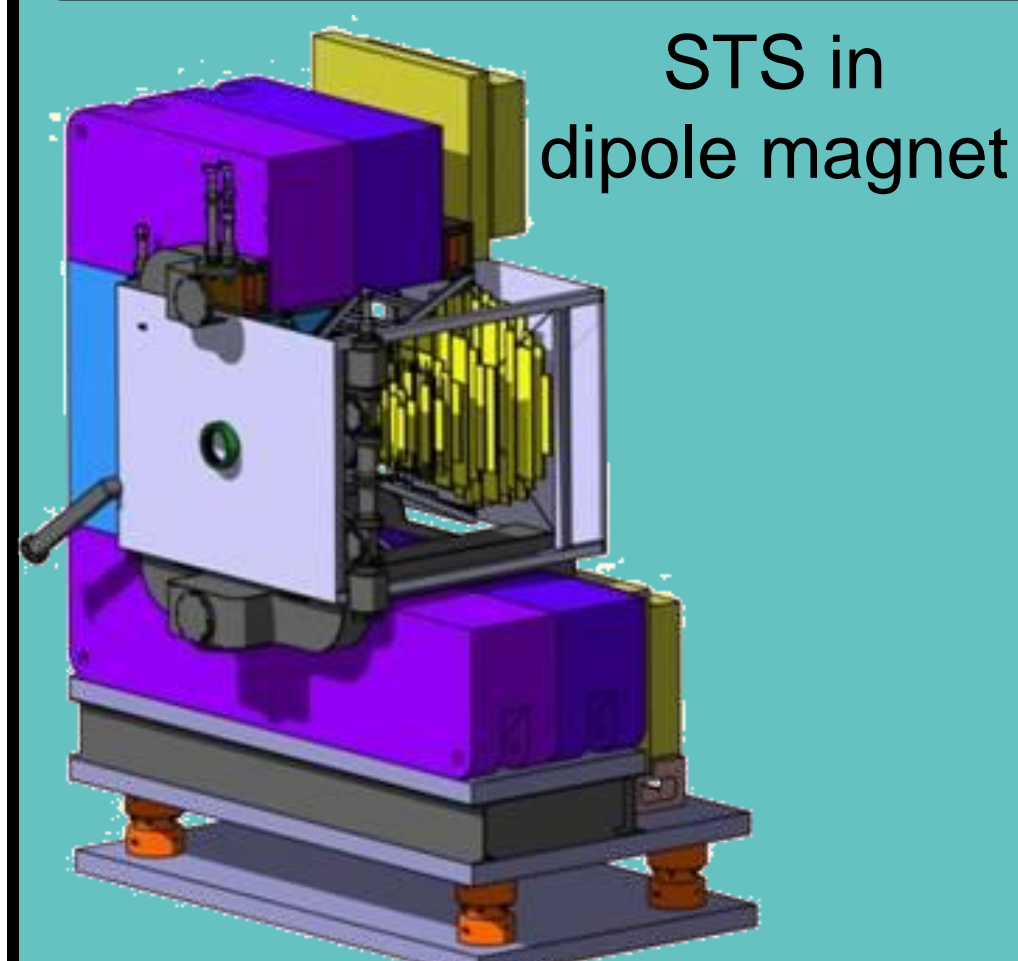
### Challenge:

- Au+Au collisions, 25A GeV
- up to 1000 charged particles/event
- interaction rates up to 10 MHz

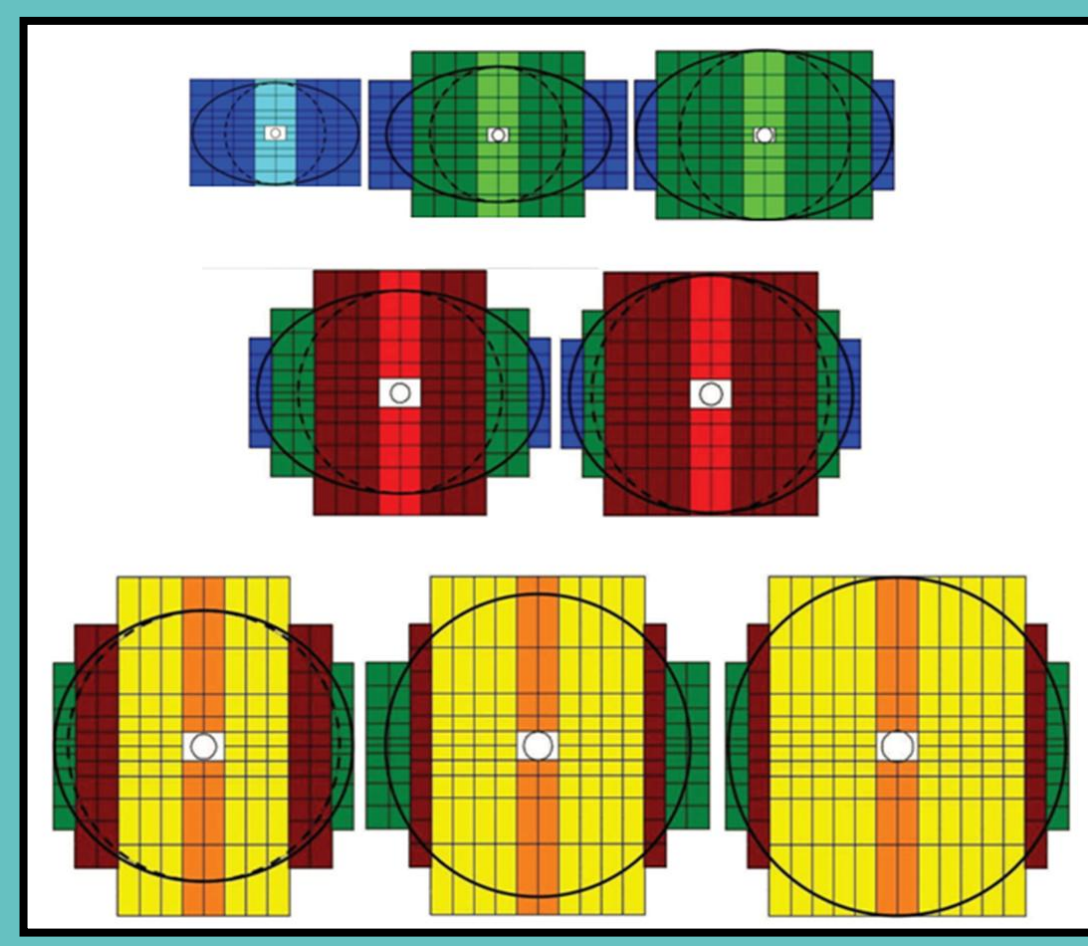
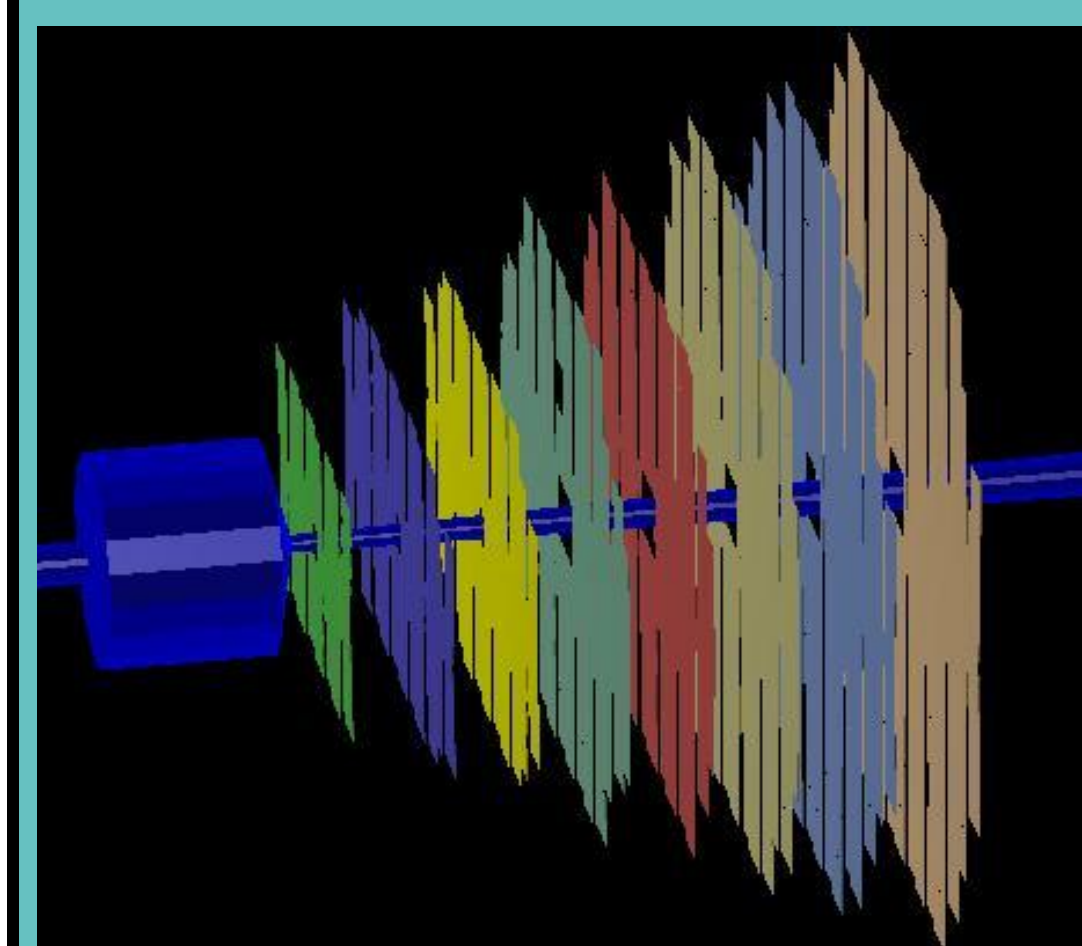
### STS requirements:

- main tracking detector system: efficient, fast, rad. hard, low-mass
- 1 MeV n fluence up to  $\sim 10^{14}/\text{cm}^2$
- momentum resolution  $\sim 1.7\%$  ( $p > 1 \text{ GeV}/c$ )

## Silicon Tracking System



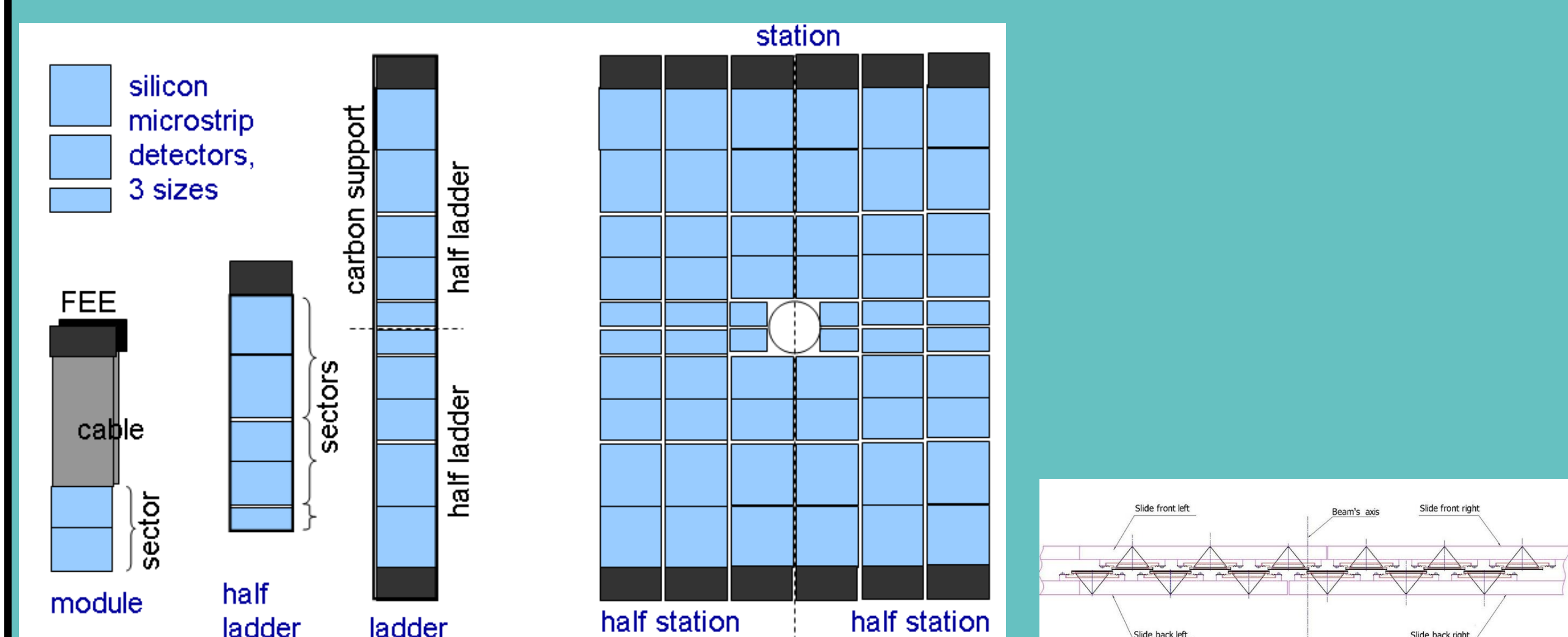
- ▶ 8 tracking stations: 30, 40, 50, 60, 70, 80, 90, 100 cm downstream of the target, in a 1 T dipole magnet;
- ▶ 4 m<sup>2</sup> active area;
- ▶ The number, positions and segmentation of the stations are optimized for efficient track reconstruction and high momentum resolution.



Realistic STS in CbmRoot

Layout of the 8 STS stations

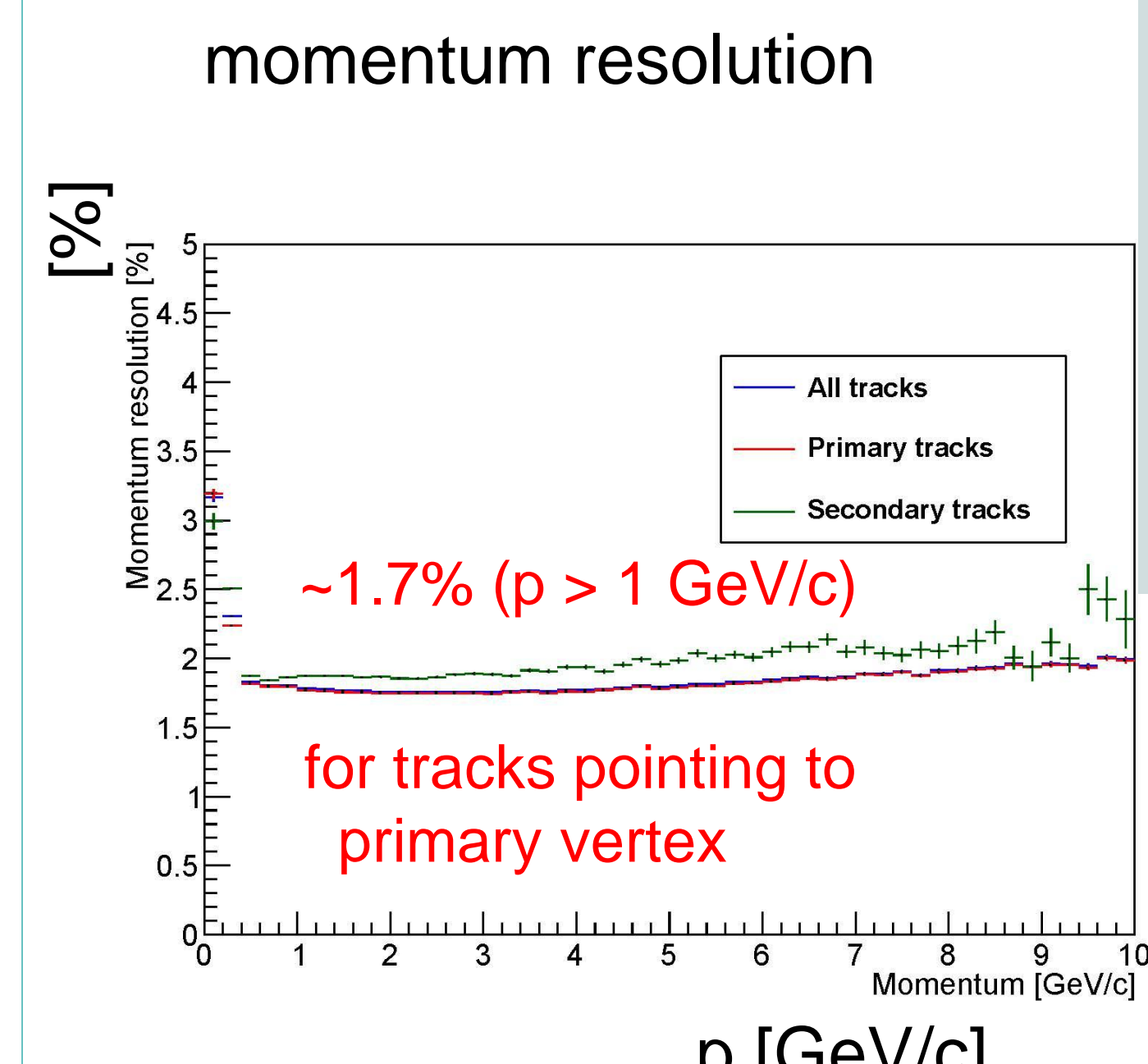
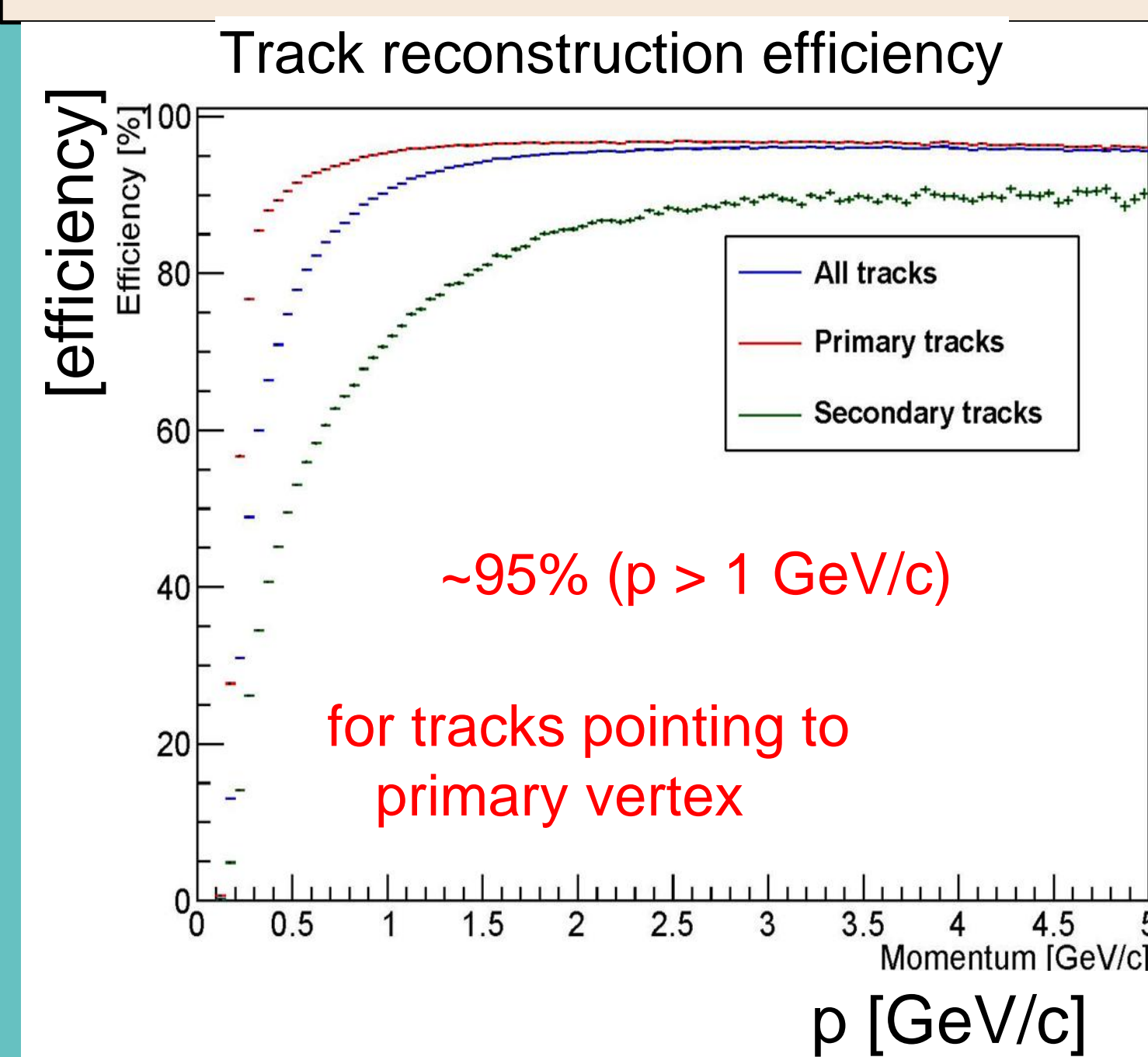
- ▶ The STS stations have a modular structure and are constructed from:
- ▶ 4 types of 300  $\mu\text{m}$  thick double-sided silicon micro-strip sensors,
- ▶ arranged on 8 types of carbon-fiber supported ladder structures.



Mechanical design of a carbon fiber support structure.

## Silicon Tracking Performance

- ▶ Detailed model of the STS in CbmRoot:
- ▶ Silicon detectors with detailed physical processes caused by traversing charged particles, mechanical supports, electronics.



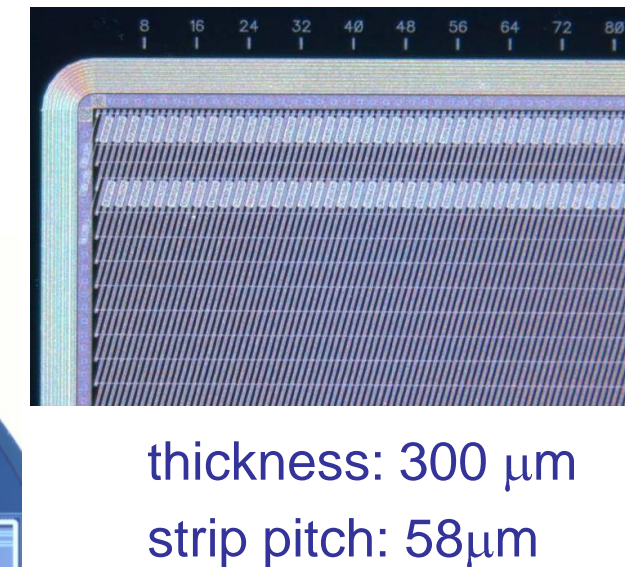
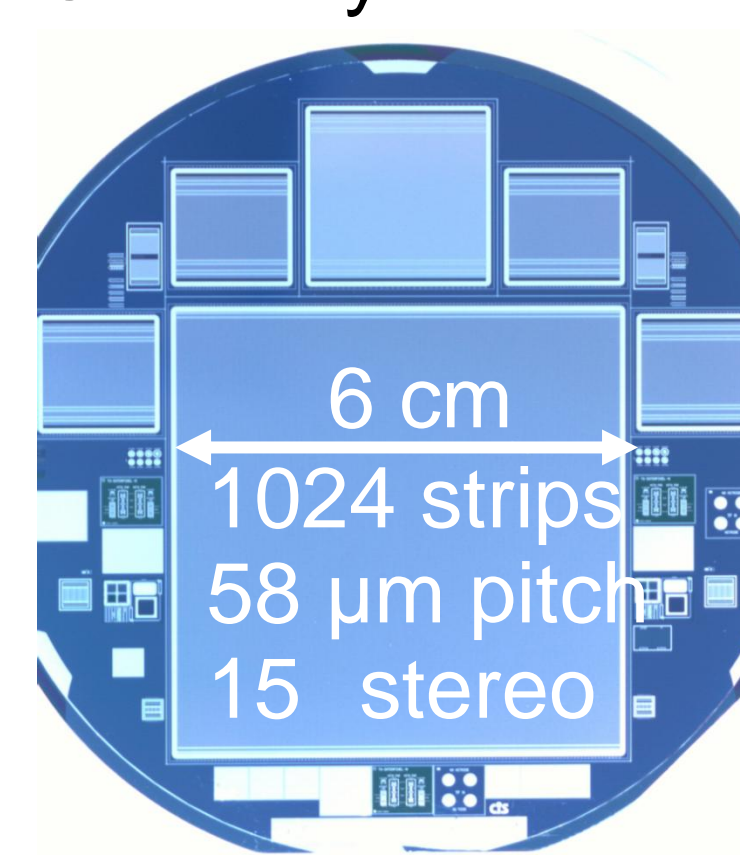
### Au+Au collisions at 25 AGeV (UrQMD)

- reconstruction with a Cellular Automaton and Kalman Filter
- 2500 min. bias events/s on an 80-core server with 4 Intel E7-4860 processors

## Prototype Components

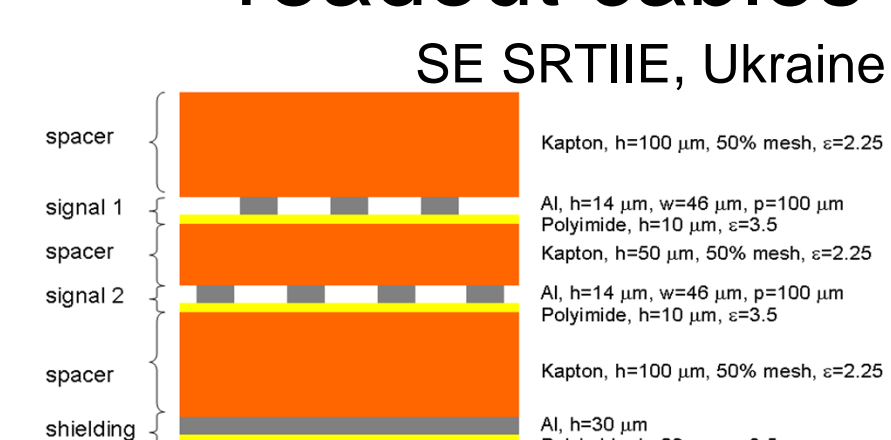
### Microstrip detectors

GSI-CIS, Germany



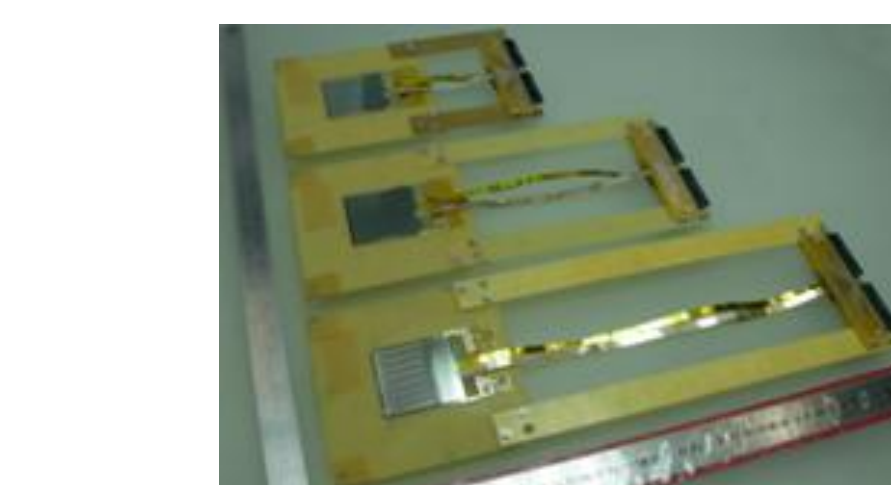
thickness: 300  $\mu\text{m}$   
strip pitch: 58  $\mu\text{m}$   
full-size prototypes: CBM01, CBM03, CBM05  
second producer of prototype sensors  
**HAMAMATSU**

### ultra-thin multi-line readout cables

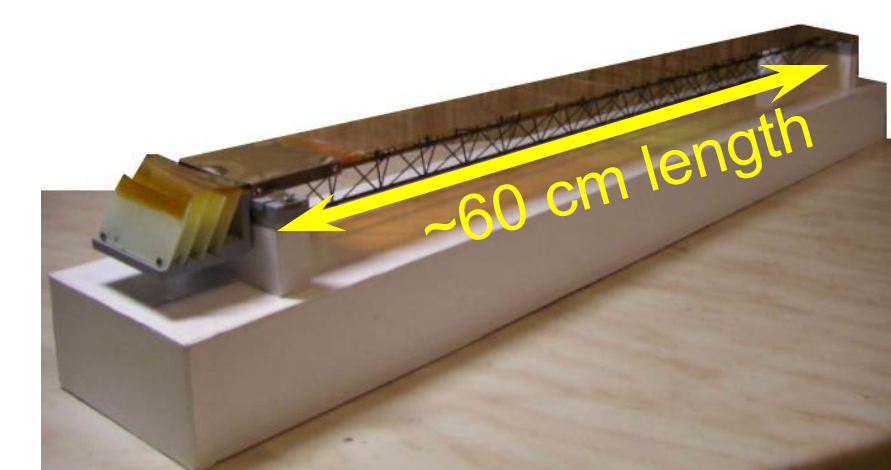


SE SRTIIE, Ukraine  
Kagtron, h=100  $\mu\text{m}$ , 50% mesh,  $\epsilon=2.25$   
Al, h=14  $\mu\text{m}$ , w=49  $\mu\text{m}$ , p=100  $\mu\text{m}$   
Polyimide, h=10  $\mu\text{m}$ ,  $\epsilon=3.5$   
Kagtron, h=50  $\mu\text{m}$ , 50% mesh,  $\epsilon=2.25$   
Al, h=14  $\mu\text{m}$ , w=49  $\mu\text{m}$ , p=100  $\mu\text{m}$   
Polyimide, h=10  $\mu\text{m}$ ,  $\epsilon=3.5$   
Al, h=20  $\mu\text{m}$   
Polyimide, h=20  $\mu\text{m}$ ,  $\epsilon=3.5$

AI strips on polyamide  
2 x 512 signal lines of 60  $\mu\text{m}$  eff. pitch  
< 0.2% radiation lengths  
Stacked cable layers attached to sensors



Detector + readout cables



Mechanical mock-up

### Self-triggering Front-end electronics

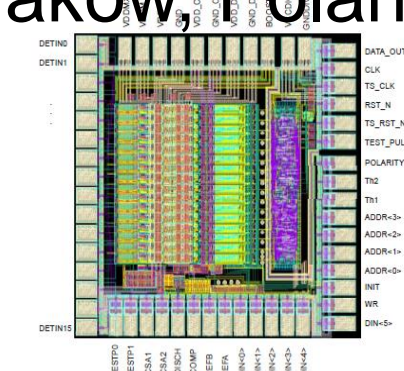
AGH Krakow, Poland



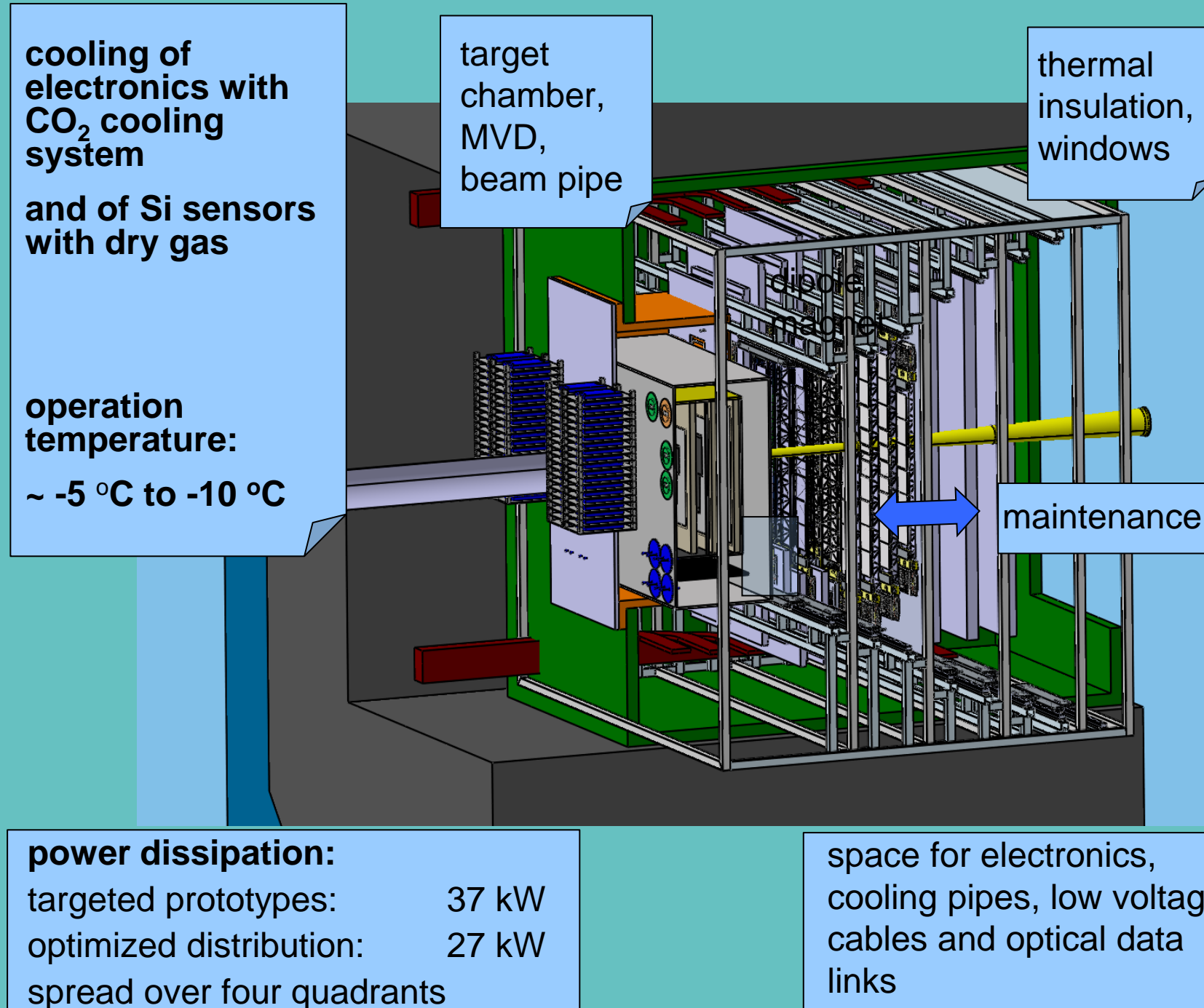
DETNI - GSI

Early prototyping with n-XYTER chip

CBM-dedicated FEE STS-XYTER chip available end 2012



## System Integration Issues and Schedule



### Timeline STS construction

Development & Engineering Design  
2012-2013

TDR  
10/2013

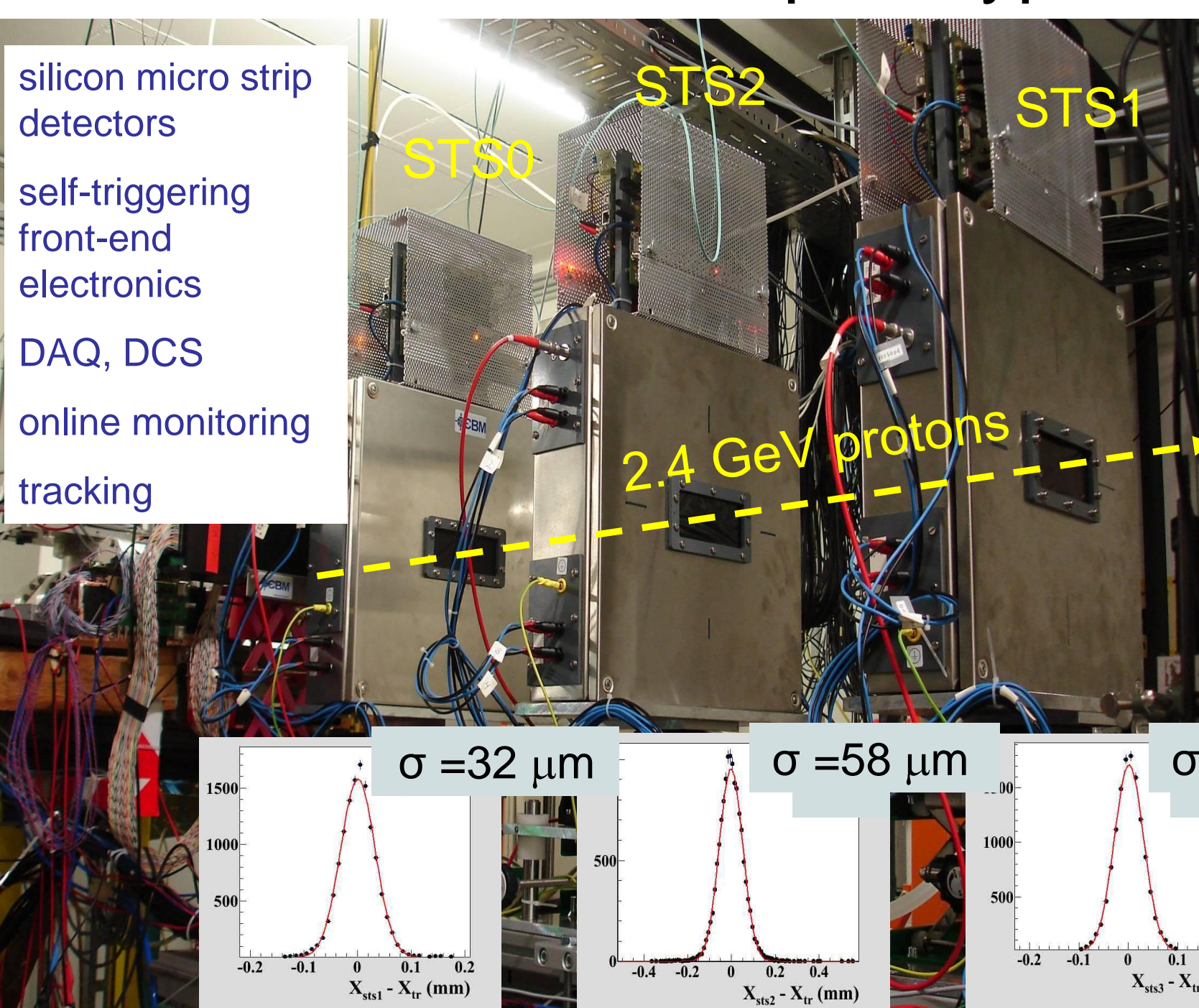
Assembly infrastructures, Prototype components  
2012 - 2014

Production & integration  
2014 - 2017

STS system ready for Installation  
2017

## Performance Evaluation

### In-beam tests of STS prototypes



### characterization of sensors

